

**CERTIFICATE OF MAILING BY FIRST CLASS MAIL (37 CFR 1.8)**

Applicant(s): Quon et al.

Docket No.

FIS920030197US1

Application No.

10/707,021

Filing Date

November 14, 2003

Examiner

Chris Chu

Customer No.

29154

Group Art Unit

2814

Invention: **STABILIZING COPPER OVERLAYER FOR ENHANCED C4 INTERCONNECT RELIABILITY**

I hereby certify that this Submission of Corrected Formal Drawings

(Identify type of correspondence)

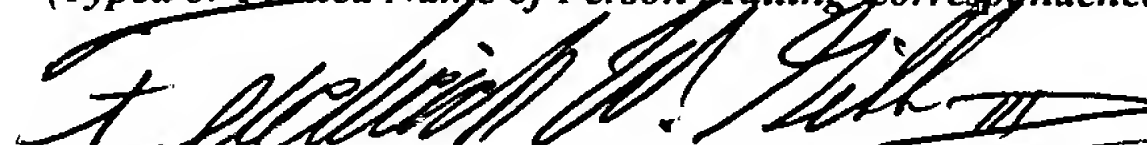
is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to "Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450" [37 CFR 1.8(a)] on

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(Date)

Frederick W. Gibb, III

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Quon et al.

Serial No.: 10/707,021

Group Art Unit: 2814

Filed: November 14, 2003

Examiner: Chris Chu

For: STABILIZING COPPER OVERLAYER FOR ENHANCED C4  
INTERCONNECT RELIABILITY

Commissioner of Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**SUBMISSION OF CORRECTED FORMAL DRAWINGS**

Sir:

Submitted herewith are two (2) sheets of formal drawings comprising Figs. 1-4 for the above-referenced patent application. Acknowledgment of receipt is respectfully requested.

Please substitute these formal drawings for the drawings which were filed with the application.

Respectfully submitted,

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9/7/04

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